

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yuki HOSAKA</td> <td>03/01/2012</td> </tr> <tr> <td>Naokazu FURUYA</td> <td>03/01/2012</td> </tr> <tr> <td>Mitsunori OHATA</td> <td>03/01/2012</td> </tr> </tbody> </table>		Name	Execution Date	Yuki HOSAKA	03/01/2012	Naokazu FURUYA	03/01/2012	Mitsunori OHATA	03/01/2012		
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<table border="1"> <tr> <td>Name:</td> <td>TOKYO ELECTRON LIMITED</td> </tr> <tr> <td>Street Address:</td> <td>3-1 Akasaka 5-chome, Minato-ku</td> </tr> <tr> <td>City:</td> <td>Tokyo</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>107-6325</td> </tr> </table>		Name:	TOKYO ELECTRON LIMITED	Street Address:	3-1 Akasaka 5-chome, Minato-ku	City:	Tokyo	State/Country:	JAPAN	Postal Code:	107-6325
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CORRESPONDENCE DATA											
<p>Fax Number: (860)286-0115</p> <p>Phone: 860-286-2929</p> <p>Email: usptopatentmail@cantorcolburn.com</p> <p><i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: CANTOR COLBURN LLP</p> <p>Address Line 1: 20 Church Street</p> <p>Address Line 2: 22nd Floor</p> <p>Address Line 4: Hartford, CONNECTICUT 06103</p>											
ATTORNEY DOCKET NUMBER:	LEE0131US										
NAME OF SUBMITTER:	Jaegyo Jang										
<p>Total Attachments: 2</p> <p>source=Assignment_LEE0131#page1.tif</p> <p>source=Assignment_LEE0131#page2.tif</p>											

CH \$40.00 13410994

ASSIGNMENT

WHEREAS We, Yuki HOSAKA, Naokazu FURUYA and Mitsunori OHATA of c/o TOKYO ELECTRON MIYAGI LIMITED, 1 Techno Hills, Taiwa-cho, Kurokawa-gun, Miyagi 981-3629 (hereinafter referred to as "ASSIGNOR") has invented certain new and useful improvements in:

PLASMA PROCESSING APPARATUS,

which claims priority to Japanese Application No. 2011-046769, filed on March 3, 2011, and U.S. Provisional Application No. 61/466,155, filed on March 22, 2011, and for which we are about to file or have filed an application for Letters Patent of the United States;

AND WHEREAS, **TOKYO ELECTRON LIMITED** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Japan, having a place of business at 3-1 Akasaka 5-chome, Minato-ku, Tokyo 107-6325, Japan, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS, have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, re-filings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

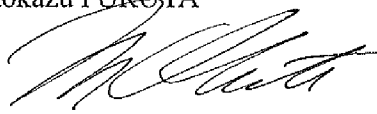
Date: Mar. 1, 2012

Yuki Hosaka L.S.
Yuki HOSAKA

Date: Mar. 1, 2012

Naokazu Furuya L.S.
Naokazu FURUYA

Date: Mar. 1, 2012

 L.S.
Mitsunori OHATA